

Low Voltage and High Speed Dual SPDT Analog Switch with True Isolation

Descriptions

The RLCS2750 is a dual SPDT low on-resistance analog switch. It can operate from a single 1.5V to 5.5V power supply. The device offers low ON-state resistance and excellent ON-state resistance matching with break-before-make feature, to prevent signal distortion during the transferring of a signal from one channel to another. The device is capable of true isolation. Even when COMx overrides VCC, very little current will flow back to the supply.

Features

- Low On-resistance, Ron=1.5Ω when COM $_X$ =5V
- > 1.8V Logic Compatible Control Pin
- > COMx Overrides VCC to Achieve True Isolation Even When Supply Is Dead
- ➤ High Off-Isolation: -100dB @ 100KHz
- ➤ Low Channel-to-Channel Crosstalk: -97dB @ 100KHz
- ➤ High Bandwidth (-3dB @700MHz) Suitable For USB2.0 High-Speed Routing
- ➤ Low Quiescent Current (<2uA) With Very Wide Supply Range (1.5V ~ 5.5V)
- TQFN-1.4x1.8-10L Package

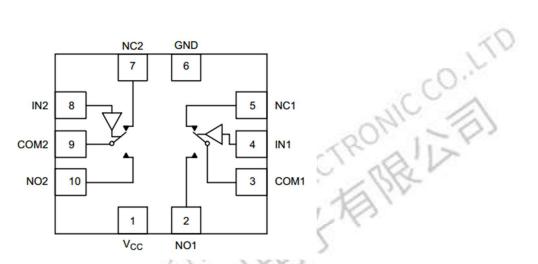
Applications

- Audio
- Video
- UART, USB2.0 Signal and Supply Routing
- Cell phones and TWS headset
- USB Type-C Mic/Gnd Switch
- > DC Motor Drive



Functions and Pin Configuration

Pin Number	Symbol	Descriptions	
1	VCC	Single Power Supply	
2,10	NOx	Analog/Digital Signal Ports (Normally open)	
3,9	COMx	Common Signal Ports	
5,7	NCx	Analog/Digital Signal Ports (Normally closed)	
6	GND	Ground	
4,8	IN _x	Logic Input Control	



Function Descriptions

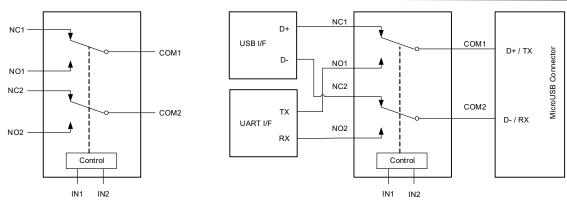
Logic Input(IN _x)	Function
0	NC1=COM1 and NC2=COM2
1 1/2	NO1=COM1 and NO2=COM2

Note: X= 1 or 2

Order Information

Pac	kage	Part Number	Quantity per Reel
QFN 1.4 x 1.8 -10L	Tape and Reel	RLCS2750QN10/R6	3000PCS





Typical Application: Configured as USB2.0 Mux

Absolute Maximum Ratings (1)

Parameter	Symbol	Value	Unit
Supply Voltage	Vcc	-0.3 ~ 6.5	V
Control Input Voltage	VIN	-0.3 ~ 6.5	V
Continuous Current Through NO, NC, COM	1	±100	mA
Peak Current Through NO, NC, COM (pulsed at 1ms 50% duty cycle)	170	±200	mA
Storage Temperature Range	Тѕтс	-55 ~ 150	°C
Junction Temperature under Bias	T ₁	150	°C
Lead Temperature (Soldering, 10 seconds)	T∟	260	°C
Power Dissipation	PD	250	mW

Recommend operating ratings (2)

Parameter	Symb	ool	Value	Unit
Supply Voltage Operating	Vcc		1.5 ~ 5.5	V
Control Input Voltage	V _{IN}		-0.3 ~ 5.5	V
Input Signal Voltage	V _{co}	М	-0.3 ~ 5.5	V
Operating Temperature	TA		-40 ~ 85	°C
Thermal Resistance	Resu	Ą	360	°C/W

Note:

1. "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress only rating and operation of the device at these or any other conditions beyond those indicated in the operational sections of this specification is not implied.

DC Electronics Characteristics (Ta=25°C, VCC=3.3V, unless otherwise noted)



Parameter	Symbol	Conditions	Min.	Тур.	Max	Unit
Input logic high level	VIH	VCC: 3.3 ~ 5.5V	1.6			V
Input logic night level	VIH	VCC: 1.5 ~ 3.3V	1.4			V
Input logic low level	VIL	VCC: 3.3 ~ 5.5V			0.6	V
Input logic low level	VIL	VCC: 1.5 ~ 3.3V			0.4	V
Supply quiescent current	Icc	$I_{COM}=0$, $V_{IN}=0$ or $V_{IN}=VCC$			1.0	uA
Increase in Icc per input	1	I _{COM} =0, VCC=4.5V			1.0	uA
increase in icc per input	Ісст	$V_{IN}>1.8 \text{ or } V_{IN}<0.5$			1.0	uA
Off state leakage from	Ісомх	$V_{COM} = 5.5V \cdot V_{NC(or\ NO)} = 0V$			±2.0	uA
COM _x to NC _x (or NO _x)	TCOMX	Vecivi C.S.V., Vive(or ive)			_2.0	G/ (
	Ron1	$V_{COM}=0 \sim 0.5V$, $I_{COM}=30$ mA		3.0	3.5	Ω
On-Resistance	R _{ON2}	$V_{COM} = 0.5 \sim 2.0 \text{V}, I_{COM} = 30 \text{mA}$		3.6	3.9	Ω
OII-Resistance	Rоnз	$V_{COM} = 2.0 \sim 4.0 \text{V}, I_{COM} = 30 \text{mA}$	190	2.5	3.5	Ω
	R _{on4}	V_{COM} =4.0 ~ 5.5V, I_{COM} =30mA	410	1.5	1.8	Ω
	R _{FLAT1}	$V_{COM} = 0 \sim 0.5 V$, $I_{COM} = 30 mA$	1/2	0.7	22	Ω
On Registance Flatness	R _{FLAT2}	V _{COM} =0.5 ~ 2.0V, I _{COM} =30mA	0	0.5		Ω
On-Resistance Flatness	R _{FLAT3}	V _{COM} =2.0 ~ 4.0V, I _{COM} =30mA	11/45	1.6		Ω
	R _{FLAT4}	V _{COM} =4.0 ~ 5.5V, I _{COM} =30mA	hr	0.3		Ω
On-Resistance	Δ Ron	V _{COM} =0~5.5V, I _{COM} =30mA,	2.	0.1	0.2	Ω
Matching Between Channels	A NON	VCOM-U-3.3V, ICOM-3UITA,		U.I	0.2	22

AC Electronics Characteristics (Ta=25°C, VCC=3.3V, unless otherwise noted)

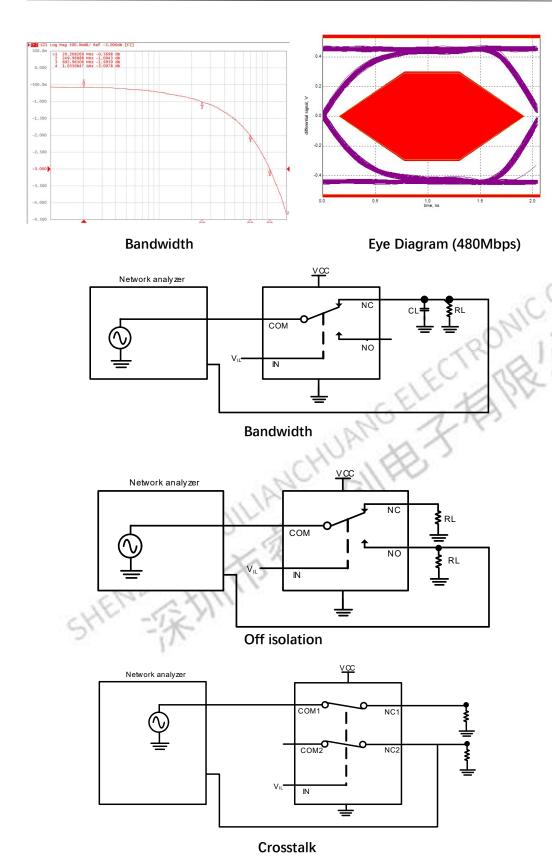
Parameter	Symbol	Conditions	Min.	Тур.	Max	Unit
Turn-On Time	Ton	V _{COM} =1.5V, C _L =35pF, R _L =50Ω		200		ns
Turn-Off Time	Toff	V_{COM} =1.5V, C_L =35pF, R_L =50 Ω		200		ns
Break-Before-Make time	Тввм	$V_{COM} = 1.5V, C_L = 35pF, R_L = 50\Omega$		500		ns
-3dB Bandwidth	BW	$R_L=50\Omega$, $C_L=0pF$		850		MHz
Off isolation	OIRR	F=1KHz, R _L =50Ω		-81		dB
Offisolation		F=10KHz, R _L =50Ω		-80		dB
Crasstall	Vtall	F=1KHz, R _L =50Ω		-83		dB
Crosstalk	Xtalk	F=10KHz, R _L =50Ω		-82		dB
Total Harmonic Distortion	TUD	F=20Hz to 20KHz		00		٩D
Total Harmonic Distortion	THD	$V_{COM}=600 \text{mVp-p} @R_L=32 \Omega,$		-80		dB

Capacitance (Ta=25°C, VCC=3.3V, unless otherwise noted)

Parameter	Symbol	Conditions	Min.	Тур.	Max.	Unit
Off capacitance	Coff	F=100KHz		5		рF
On capacitance	Con	F=100KHz		7		рF

Typical Characteristics (Ta=25°C, VCC=3.3V, unless otherwise noted)

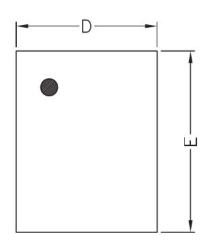


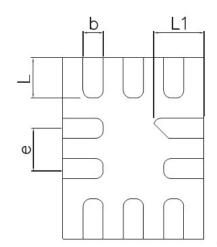


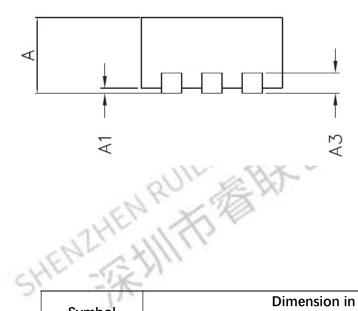
Package Outline Dimensions



QFN1418-10L







Symbol	Dimension	in Millimeters		
Symbol	Min.	Max.		
А	0.450	0.550		
A1	0.000	0.050		
A3	0.15	0.152 Ref.		
D	1.350	1.450		
E	1.750	1.850		
b	0.150	0.250		
е	0.40	0.400 Тур.		
L	0.350	0.450		
L1	0.450	0.550		



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